

STTH6010-Y

Automotive ultrafast recovery - high voltage diode

Features

- AEC-Q101 qualified
- Ultrafast, soft recovery
- Very low conduction and switching losses
- High frequency and/or high pulsed current operation
- High reverse voltage capability
- High junction temperature
- ECOPACK[®]2 compliant component

Description

The high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability like automotive applications.

These diodes also fit into auxiliary functions such as snubber, bootstrap, and demagnetization applications.

The improved performance in low leakage current, and therefore thermal runaway guard band, is an immediate competitive advantage for this device.

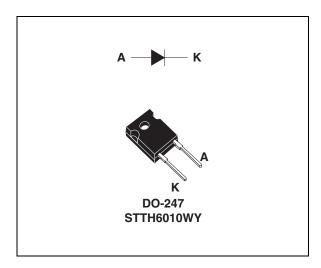


Table 1. Device summary

	•
I _{F(AV)}	60 A
V _{RRM}	1000 V
T _j	175 °C
V _F (typ)	1.3 V
t _{rr} (typ)	49 ns

Characteristics Device name or AN #

1 Characteristics

Table 2. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Pa	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage			
I _{F(RMS)}	Forward rms current			80	Α
I _{F(AV)}	Average forward current, $\delta = 0.5$	Average forward current, δ = 0.5 T_c = 75 °C			
I _{FRM}	Repetitive peak forward current	Repetitive peak forward current $t_p = 5 \mu s$, $F = 5 kHz square$			
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$				Α
T _{stg}	Storage temperature range	-65 to +175	°C		
T _j	Operating junction temperature range	-40 to +175	°C		

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	0.78	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _R ⁽¹⁾	Poverse leekage ourrent	T _j = 25 °C	V - V			20	
R`′	$I_{R}^{(1)}$ Reverse leakage current $T_{j} = 125 ^{\circ}\text{C}$ $V_{R} = V_{RRM}$		20	200	μΑ		
		T _j = 25 °C				2.0	
V _F ⁽²⁾ Forw	orward voltage drop	T _j = 100 °C	I _F = 60 A		1.4	1.8	V
		T _j = 150 °C			1.3	1.7	

- 1. Pulse test: t_p = 5 ms, δ < 2 %
- 2. Pulse test: t_p = 380 μ s, δ < 2 %

To evaluate the conduction losses use the following equation:

$$P = 1.3 \text{ x } I_{F(AV)} + 0.0067 I_{F}^{2}_{(RMS)}$$

Device name or AN # Characteristics

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур	Max.	Unit
		$I_F = 1 \text{ A, } dI_F/dt = -50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25 \text{ °C}$			115	
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25 \text{ °C}$		61	80	ns
	$I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25 \text{ °C}$		49	65		
I _{RM}	Reverse recovery current	$I_F = 60 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 600 \text{ V}, T_j = 125 ^{\circ}\text{C}$		31	40	Α
S	Softness factor	$I_F = 60 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 600 \text{ V}, T_j = 125 ^{\circ}\text{C}$		1		
t _{fr}	Forward recovery time	$I_F = 60 \text{ A}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.5 \text{ x } V_{Fmax}, T_j = 25 \text{ °C}$			750	ns
V _{FP}	Forward recovery voltage	$I_F = 60 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s},$ $T_j = 25 ^{\circ}\text{C}$		4		٧

Figure 1. Conduction losses versus average current

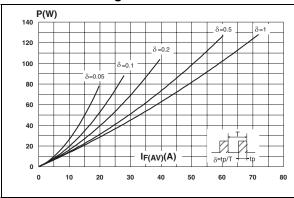


Figure 2. Forward voltage drop versus forward current

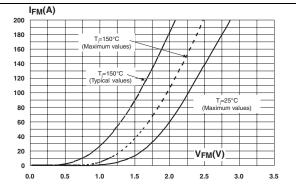


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

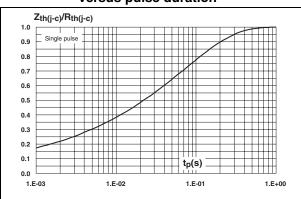
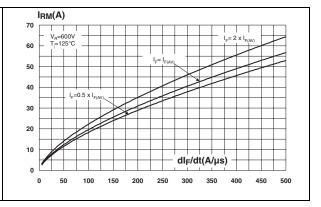


Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)



Characteristics Device name or AN #

Figure 5. Reverse recovery time versus dl_F/dt (typical values)

t_{rr}(ns)

500 400

300

200

100

V_E=600V V_E=600V T_i=125°C 8 7 6 5 4

Figure 6. Reverse recovery charges versus dl_F/dt (typical values)

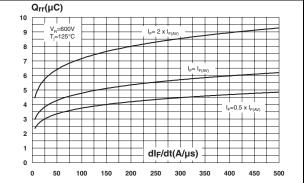


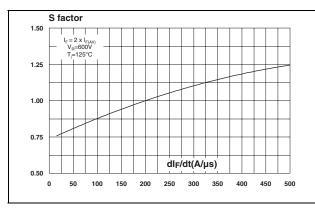
Figure 7. Softness factor versus dl_F/dt (typical values)

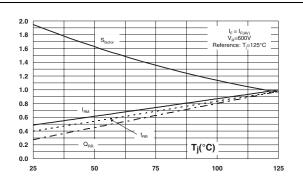
150

dlf/dt(A/µs)

350

Figure 8. Relative variations of dynamic parameters versus junction temperature



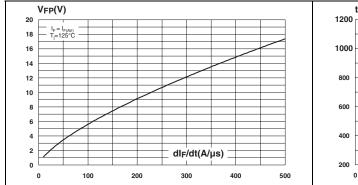


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Figure 9. Transient peak forward voltage versus dl_F/dt (typical values)

Figure 10. Forward recovery time versus dI_F/dt (typical values)



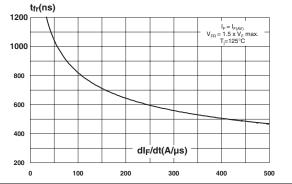
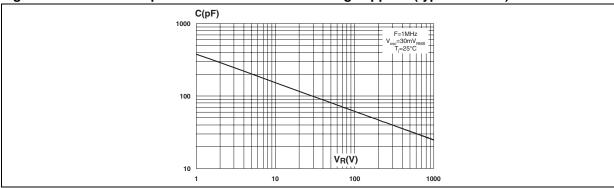


Figure 11. Junction capacitance versus reverse voltage applied (typical values)



2 Package information

Epoxy meets UL94, V0

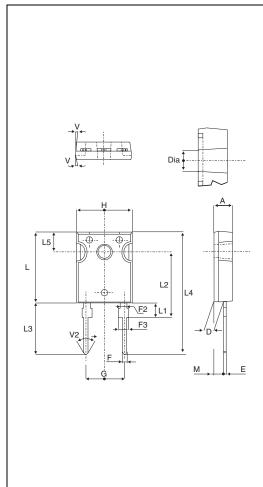
Cooling method: by conduction (C)

Recommended torque value: 0.80 N⋅m

Maximum torque value: 1.0 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 6. DO-247 dimensions



	Dimensions					
Ref.	Millimeters			Inches		
	Min.		Max	Min.		Max.
Α	4.85		5.15	0.191		0.203
D	2.20		2.60	0.086		0.102
Е	0.40		0.80	0.015		0.031
F	1.00		1.40	0.039		0.055
F2		2.00			0.078	
F3	2.00		2.40	0.078		0.094
G		10.90			0.429	
Н	15.45		15.75	0.608		0.620
L	19.85		20.15	0.781		0.793
L1	3.70		4.30	0.145		0.169
L2		18.50			0.728	
L3	14.20		14.80	0.559		0.582
L4		34.60			1.362	
L5		5.50			0.216	
М	2.00		3.00	0.078		0.118
V		5°			5°	
V2		60°			60°	
Dia.	3.55		3.65	0.139		0.143

3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH6010WY	STTH6010WY	DO-247	4.4 g	30	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
04-Nov-2011	1	Initial release.

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Authorized Distribution Brand:

























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